# 1A Synchronous PWM/PSM Step-Down DCIDC Converter 

## FEATURES

- 2.5 V to 5.5 V Input Voltage Range
- 1.0A Guaranteed Output Current
- Up to $95 \%$ Efficiency
- Low $\mathrm{R}_{\mathrm{DS}(\mathrm{ON})}$ Internal Switche: $280 \mathrm{~m} \Omega$
- No Schottky Diode Required
- 100\% Duty Cycle in Low Dropout Operation
- Operating Frequency: 1.5 MHz
- Accurate Reference 0.6V Provides Low Output Voltages


## APPLICATIONS

- LCD TV
- Multi-function Peripheral
- Cellular Phones
- CPU I/O Supplies
- Cordless Phones
- PDAs and Handy-Terminals
- Battery-Operated Devices (1 Li-lon or 3 NiMH/ NiCd)


## DESCRIPTION

The AIC2354 is a low-noise, pulse-widthmodulated (PWM), DC-DC step-down converter.
The device is available in an adjustable version and fixed output voltages of $1.0 \mathrm{~V}, 1.2 \mathrm{~V}, 1.5 \mathrm{~V}$, 1.8 V , and 3.3 V .

The device features an internal synchronous rectifier for high efficiency; it requires no external Schottky diode. The AIC2354 is ideally suited for Li-Ion battery applications. PWM/PSM mode extends battery life by switching to a pulse-skipping-modulated mode during light loads. Shutdown mode places the device in standby, reducing supply current to under $1 \mu \mathrm{~A}$.
Other features of the AIC2354 include high efficiency, low dropout voltage, short circuit protection, over temperature protection, and over voltage protection. It is available in a small 5 pins SOT-23 and a 6 pins DFN package.

## APPLICATIONS CIRCUIT



Fig. 1 Fixed Step-Down DC/DC Converter


Fig. 2 Adjustable Step-Down DC/DC Converter

## ORDERING INFORMATION



Example: AIC2354-33GV5TR
$\rightarrow$ 3.3V Output Version, in SOT-23-5 Green Package \& Tape \& Reel Packing Type
AIC2354GV5TR
$\rightarrow$ Adjustable Version, in SOT-23-5 Green Package \& Tape \& Reel Packing Type


ORDERING INFORMATION (Continuous)

- Marking (Fixed Version)

| Part No. | Marking |
| :---: | :---: |
| AIC2354-10GV5 | GZ10G |
| AIC2354-12GV5 | GZ12G |
| AIC2354-15GV5 | GZ15G |
| AIC2354-18GV5 | GZ18G |
| AIC2354-33GV5 | GZ33G |
| AIC2354-10GDA | HQ10G |
| AIC2354-12GDA | HQ12G |
| AIC2354-15GDA | HQ15G |
| AIC2354-18GDA | HQ18G |
| AIC2354-33GDA | HQ33G |

- Marking (Adjustable Version)

| Part No. | Marking |
| :---: | :---: |
| AIC2354GV5 | $2354 G$ |
| AIC2354GDA | 2354 A |

## ABSOLUTE MAXIMUM RATINGS

VIN, LX Voltage ...................................................................................................................................................... 6 V
EN, FB Pin Voltage ............................................................................................................... 0.3 V to $\mathrm{V}_{\mathrm{IN}}$


Storage Temperature Range TSTG. $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$
Lead Temperature (Soldering 10 Sec .) $260^{\circ} \mathrm{C}$
Thermal Resistance Junction to Case DFN-6L (2x2) ..... $30^{\circ} \mathrm{C} / \mathrm{W}$
Thermal Resistance Junction to Case SOT-23-5 ..... $115^{\circ} \mathrm{C} / \mathrm{W}$
Thermal Resistance Junction to Ambient DFN-6L (2x2)* ..... $165^{\circ} \mathrm{C} / \mathrm{W}$
Thermal Resistance Junction to Ambient SOT-23-5 ..... $250^{\circ} \mathrm{C} / \mathrm{W}$
(Assume no Ambient Airflow)
Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

* The package is placed on a two layers PCB with 2 ounces copper and 2 square inch, connected by 8 vias.

ELECTRICAL CHARACTERISTICS
( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\text {IN }}=3.6 \mathrm{~V}$ unless otherwise specified.) (Note 1)

| PARAMETER | CONDITIONS | SYMBOL | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Input Voltage Range |  | $\mathrm{V}_{\text {IN }}$ | 2.5 |  | 5.5 | V |
| Output Adjustment Range |  | $V_{\text {Out }}$ | 0.6V |  | $\mathrm{V}_{\text {IN }}-0.3 \mathrm{~V}$ | V |
| Reference Voltage |  | $\mathrm{V}_{\text {REF }}$ | 0.588 | 0.6 | 0.612 | V |
| FB Input Current | $\mathrm{V}_{\mathrm{FB}}=\mathrm{V}_{\mathrm{IN}}$ | $I_{\text {fB }}$ | -50 |  | 50 | nA |
| P-Channel On-Resistance | $\mathrm{l}_{\text {OUT }}=0.2 \mathrm{~A}$ | $\mathrm{P}_{\text {RDS(ON) }}$ |  | 280 | 390 | $\mathrm{m} \Omega$ |
| N-Channel On-Resistance | $\mathrm{l}_{\text {OUT }}=0.2 \mathrm{~A}$ | $\mathrm{N}_{\text {RDS(ON) }}$ |  | 250 | 390 | $\mathrm{m} \Omega$ |
| LX Leakage Current | $\mathrm{V}_{\mathrm{LX}}=0 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{L}}=3.6 \mathrm{~V}$ |  | -1 |  | 1 | $\mu \mathrm{A}$ |
| Peak Inductor Current | $\mathrm{V}_{\text {IN }}=5 \mathrm{~V}$ | $\mathrm{I}_{\mathrm{PK}}$ | 1.3 | 1.6 |  | A |
| Quiescent Current | $\begin{aligned} & \text { lout }=0 \mathrm{~mA}, \\ & \mathrm{~V}_{\text {FB }}=\mathrm{V}_{\text {REF }}+5 \% \end{aligned}$ | $\mathrm{I}_{0}$ |  | 65 | 85 | $\mu \mathrm{A}$ |
| Shutdown Supply Current | EN = GND | $I_{\text {SHDN }}$ |  | 0.1 | 1 | $\mu \mathrm{A}$ |
| EN High-Level Input Voltage | $\mathrm{V}_{\text {IN }}=2.5 \mathrm{~V}$ to 5.5 V | $\mathrm{V}_{\text {En_h }}$ | 1.5 |  |  | V |
| EN Low-Level Input Voltage | $\mathrm{V}_{\text {IN }}=2.5 \mathrm{~V}$ to 5.5 V | $\mathrm{V}_{\text {En_L }}$ |  |  | 0.4 | V |
| Oscillator Frequency |  | $\mathrm{f}_{\text {osc }}$ | 1.2 | 1.5 | 1.8 | MHz |
| Maximum Duty Cycle |  | $\mathrm{D}_{\text {MAX }}$ | 100 |  |  | \% |
| Thermal Shutdown Temperature |  |  |  | 150 |  | ${ }^{\circ} \mathrm{C}$ |
| Thermal Shutdown Hysteresis |  |  |  | 25 |  | ${ }^{\circ} \mathrm{C}$ |

Note 1: Specifications are production tested at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$. Specifications over the $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ operating temperature range are assured by design, characterization and correlation with Statistical Quality Controls (SQC).

## TYPICAL PERFORMANCE CHARACTERISTICS



Fig. 3 Efficiency vs. Input Voltage


Fig. 5 Efficiency vs. Output Current


Fig. 7 Output Voltage vs. Temperature


Fig. 4 Efficiency vs. Output Current


Fig. 6 Efficiency vs. Output Current


Fig. 8 Oscillator Frequency vs. Temperature

AIC2354

TYPICAL PERFORMANCE CHARACTERISTICS (Continuous)


Fig. 9 Oscillator Frequency vs. Input Voltage


Fig. 11 Supply Current vs. Input Voltage


Fig. 13 Load Transient Response


Fig. $10 \mathrm{R}_{\mathrm{DS}(\mathrm{ON})} \mathrm{vs}$. Input Voltage


Fig. 12 Current Limit vs. Input Voltage


Fig. 14 Load Transient Response

## TYPICAL PERFORMANCE CHARACTERISTICS (Continuous)



Fig. 15 Load Transient Response


Fig. 17 Load Transient Response


Fig. 16 Load Transient Response


Fig. 18 PSM Operation

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## BLOCK DIAGRAM



Functional Block Diagram of AIC2354

PIN DESCRIPTIONS

| Pin <br> DFN-6L | Pin <br> SOT-23 | Pin Name | Pin Function |
| :---: | :---: | :---: | :--- |
| 1 |  | NC | No Internal Connect (Floating or Connecting to GND). |
| 2 | 1 | EN | Chip Enable (Active High). |
| 3 | 4 | VIN | Power Input. |
| 4 | 3 | LX | Pin for Switching. |
| 5 | 2 | GND | Ground. |
| 6 | 5 | FB/VOUT | Feedback/Output Voltage Pin. |

## APPLICATION INFORMATION

 OperationThe AIC2354 is a low-noise step-down DC/DC converter with current-mode PWM/PSM control architecture. It features an internal synchronous rectifier, which eliminates the external Schottky diode and increases efficiency. During normal operation, the AIC2354 can regulate its output voltage through a feedback control circuit, which is composed of an error amplifier; a current comparator and several control signal generators. By comparing the feedback voltage to the reference voltage of 0.6 V , the error amplifier varies its output voltage. The output voltage of the error amplifier is compared with the summing signal of current sensing signal and slope compensation signal to determine the duty cycle of internal main power switch (P-channel MOSFET). While the main power switch is turned on, the synchronous power switch ( N channel MOSFET) will be turned off through anti-shortthrough block. Similarly, when the main power switch is turned off, the synchronous power switch will be turned on until the inductor current starts to reverse or the beginning of the next switching cycle. In order to achieve better efficiency and prevent overcharging the output capacitor, AIC2354 will enter pulse-skippingmodulated mode (PSM) operation while working at light load conditions.

## Current Limitation

The AIC2354 provides current limit function by using an internal sensing resistor. When the main power switch turns on, current follows through the internal sensing resistor. And current amplifier senses the voltage, which crosses the resistor, and amplifies it. While the sensed voltage gets higher than reference voltage, the current limitation function is activated. While the current limitation function is activated, the duty cycle will be reduced to limit the output power to protect the internal power switches.

## Short Circuit Protection

While the output is shorted to ground, the switching frequency of AIC2354 will be reduced to one third of the normal switching frequency. This lower switching frequency ensures the inductor current has more time to discharge, thereby preventing inductor current runaway. The switching frequency will automatically return to its designed value while short circuit condition is released.

## Shutdown

By connecting the EN pin to GND, the AIC2354 can be shut down to reduce the supply current to $0.1 \mu \mathrm{~A}$ (typical). At this operation mode, the output voltage of step-down converter is equal to 0 V .

## 100\% Duty Cycle Operation

When the input voltage approaches the output voltage, the AIC2354 smoothly transits to $100 \%$ duty cycle operation. This allows AIC2354 to regulate the output voltage until AIC2354 completely enters 100\% duty cycle operation. In 100\% duty cycle mode, the output voltage is equal to the input voltage minus the voltage, which is the drop across the main power switch.
The AIC2354 achieves 100\% duty cycle operation by extending the turn-on time of the main power switch. If the summing signal of current sensing signal and slope compensation signal does not reach the output voltage level of the error amplifier at the end of $90 \%$ switching period, the main power switch is continuously turned on and the oscillator remains off until the summing signal of current sensing signal and slope compensation signal reaches the output voltage level of the error amplifier. After the summing signal of current sensing signal and slope compensation signal reaches the output voltage level of the error amplifier, the main power switch is turned off and the synchronous power switch is turned on for a constant off time. At the end of the constant off time, the next
switching cycle is begun. While the input voltage approaches the output voltage, the switching frequency decreases gradually to smoothly transit to 100\% duty cycle operation.
If input voltage is very close to output voltage, the switching mode goes from pure PWM mode to $100 \%$ duty cycle operation. During this transient state mentioned above, large output ripple voltage may appear on output terminal.

## Components Selection

## Inductor

The inductor selection depends on the current ripple of inductor, the input voltage and the output voltage.
$\mathrm{L} \geq \frac{\mathrm{V}_{\mathrm{OUT}}}{\mathrm{f}_{\mathrm{OSC}} \cdot \Delta \mathrm{I}_{\mathrm{L}}}\left(1-\frac{\mathrm{V}_{\mathrm{OUT}}}{\mathrm{V}_{\mathrm{IN}}}\right)$
Accepting a large current ripple of inductor allows the use of a smaller inductance. However, higher current ripple of inductor can cause higher output ripple voltage and large core loss. By setting an acceptable current ripple of inductor, a suitable inductance can be obtained from above equation.
In addition, it is important to ensure the inductor saturation current exceeds the peak value of inductor current in application to prevent core saturation. The peak value of inductor current can be calculated according to the following equation.
$\mathrm{I}_{\text {PEAK }}=\mathrm{I}_{\mathrm{OUT}(\max )}+\frac{\mathrm{V}_{\text {OUT }}}{2 \times \mathrm{f}_{\mathrm{OSC}} \cdot \mathrm{L}}\left(1-\frac{\mathrm{V}_{\mathrm{OUT}}}{\mathrm{V}_{\mathrm{IN}}}\right)$

## Input Capacitor and Output Capacitor

To prevent the high input voltage ripple and noise resulted from high frequency switching, the use of low ESR ceramic capacitor for the maximum RMS current is recommended. The approximated RMS current of the input capacitor can be calculated according to the following equation.
$\mathrm{I}_{\mathrm{CINRMS}} \approx \sqrt{\mathrm{I}_{\mathrm{OUT}(\mathrm{MAX})}^{2} \times \frac{\mathrm{V}_{\text {OUT }}\left(\mathrm{V}_{\text {IN }}-\mathrm{V}_{\text {OUT }}\right)}{\mathrm{V}_{\mathrm{IN}}^{2}}+\frac{\Delta \mathrm{L}_{\mathrm{L}}^{2}}{12}}$

The selection of output capacitor depends on the required output voltage ripple. The output voltage ripple can be expressed as:

$$
\Delta \mathrm{V}_{\text {OUT }}=\frac{\Delta \mathrm{I}_{\mathrm{L}}}{8 \times \mathrm{f}_{\mathrm{OSC}} \cdot \mathrm{C}_{\text {OUT }}}+\mathrm{ESR} \cdot \Delta \mathrm{I}_{\mathrm{L}}
$$

For lower output voltage ripple, the use of low ESR ceramic capacitor is recommended. The tantalum capacitor can also be used well, but its ERS is larger than that of ceramic capacitor.

When choosing the input and output ceramic capacitors, X5R and X7R types are recommended because they retain their capacitance over wider ranges of voltage and temperature than other types.

## Output Voltage Programming (AIC2354 Adjustable Version Only) <br> By connecting a resistive divider $\mathrm{R}_{1}$ and $\mathrm{R}_{2}$, the output voltage of AIC2354 step-down converter can be set. $\mathrm{V}_{\text {OUt }}$ can be calculated as:

$$
\mathrm{V}_{\text {OUT }}=0.6 \times\left(1+\frac{\mathrm{R}_{1}}{\mathrm{R}_{2}}\right)
$$

The resistive divider should sit as close to VFB pin as possible.

## Layout Consideration

In order to ensure a proper operation of AIC2354, the following points should be managed comprehensively.

1. The input capacitor and $\mathrm{V}_{\mathrm{IN}}$ should be placed as close as possible to each other to reduce the input voltage ripple and noise.
2. The output loop, which is consisted of the inductor, the internal main power switch, the internal synchronous power switch and the output capacitor, should be kept as small as possible.
3. The routes with large current should be kept short and wide.
4. Logically the large current on the converter should flow at the same direction.
5. The VFB pin should be connected to the feedback resistors directly and the route should be away from the noise sources.

## PHYSICAL DIMENSIONS

- SOT-23-5


Note : 1. Refer to JEDEC MO-178AA.
2. Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 10 mil per side.
3. Dimension "E1" does not include inter-lead flash or protrusions.
4. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

\left.| S | SOT-23-5 |  |
| :--- | :--- | :--- |
|  |  |  |
| B |  |  |
| o |  |  |
| L |  |  |$\right)$

- DFN 6L-2X2


TOP VIEW


SIDE VIEW


BOTTOM VIEW

| $\begin{aligned} & \hline \text { S } \\ & \text { Y } \\ & \text { M } \\ & \text { B } \\ & \text { L } \end{aligned}$ | DFN 6L-2x2x0.75-0.65mm |  |
| :---: | :---: | :---: |
|  | MILLIMETERS |  |
|  | MIN. | MAX. |
| A | 0.70 | 0.80 |
| A3 | 0.20 BSC |  |
| b | 0.25 | 0.35 |
| D | 2.00 BSC |  |
| D2 | 1.20 | 1.60 |
| E | 2.00 BSC |  |
| E2 | 0.55 | 0.85 |
| e | 0.65 BSC |  |
| L | 0.25 | 0.45 |

Note : 1. DIMENSION AND TOLERANCING CONFORM TO ASME Y14.5M-1994.
2.CONTROLLING DIMENSIONS : MILLIMETER, CONVERTED INCH

DIMENSION ARE NOT NECESSARILY EXACT.

## 3.DIMENSION b APPLIES TO METALLIZED TERMINAL AND IS <br> MEASURED BETWEEN 0.10 AND 0.25 mm FROM TERMINAL TIP.

## Note:

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